## CMOS－Low－Power，Slew－Rate－Limited RS－485／RS－422 Transceivers

## GENERAL DESCRIPTION

The HT8485 is low－power transceivers for RS－485 and RS－422 communication．IC contains one driver and one receiver．The driver slew rates of the HT8485 is not limited，allowing them to transmit up to 2.5 Mbps ．These transceivers draw between $120 \mu \mathrm{~A}$ and $500 \mu \mathrm{~A}$ of supply current when unloaded or fully loaded with disabled drivers．All parts operate from a single 5V supply．Drivers are short－circuit current limited and are protected against excessive power dissipation by thermal shutdown circuitry that places the driver outputs into a high－impedance state．The receiver input has a fail－safe feature that guarantees a logic－high output if the input is open circuit．The HT8485 is designed for half－duplex applications．

## FEATURES

－Extended ESD Protection for RS－485／RS－422 I／OPins $\pm 15 \mathrm{kV}$ Using Human Body Model
－Low Quiescent Current： $300 \mu \mathrm{~A}$
－-7 V to +12 V Common－Mode Input Voltage Range
－Three－StateOutputs
－30ns Propagation Delays，5ns Skew
－Full－Duplex and Half－Duplex Versions Available
－Operate from a Single 5V Supply
－Allows up to 32 Transceivers on the Bus
－Data rate： $2,5 \mathrm{Mbps}$
－Current－Limiting and Thermal Shutdown for Driver Overload Protection


Pinning


## ABSOLUTE MAXIMUM RATINGS

Supply Voltage（VCC）12V
Control Input Voltage -0.5 V to $(\mathrm{V} \mathrm{Cc}+0.5 \mathrm{~V})$
Driver Input Voltage（DI）-0.5 V to $(\mathrm{V} \mathrm{Cc}+0.5 \mathrm{~V})$
Driver Output Voltage（A，B）-8 V to +12.5 V
Receiver Input Voltage（A，B）-8 V to +12.5 V
Receiver Output Voltage（RO）-0.5 V to $\left(\mathrm{V}_{\mathrm{cc}}+0.5 \mathrm{~V}\right)$

Continuous Power Dissipation
8－Pin Plastic DIP（derate $9.09 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ ） 727 mW
8 －Pin SO（derate $5.88 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ ） 471 mW
Operating Temperature Ranges $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range $-65^{\circ} \mathrm{C}$ to $+160^{\circ} \mathrm{C}$
Lead Temperature（soldering， 10 sec ）$+300^{\circ} \mathrm{C}$

## DC ELECTRICAL CHARACTERISTICS

（ $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {Min }}$ to $\mathrm{T}_{\text {MAX }}$ ，unless otherwise noted．）（Notes 1，2）

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Differential Driver Output（no load） | VOD1 |  |  |  |  | 5 | V |
| Differential Driver Output （with load） | VOD2 | $\mathrm{R}=50 \Omega$（RS－422） |  | 2 |  |  | V |
|  |  | $R=27 \Omega$（RS－485），Figure 4 |  | 1.5 |  | 5 |  |
| Change in Magnitude of Driver Differential Output Voltage for Complementary Output States | $\triangle \mathrm{VOD}$ | $R=27 \Omega$ or $50 \Omega$ ，Figure 4 |  |  |  | 0.2 | V |
| Driver Common－Mode Output Voltage | VOC | $\mathrm{R}=27 \Omega$ or $50 \Omega$ ，Figure 4 |  |  |  | 3 | V |
| Change in Magnitude of Driver Common－Mode Output Voltage for Complementary Output States | $\Delta \mathrm{VOC}$ | $\mathrm{R}=27 \Omega$ or $50 \Omega$ ，Figure 4 |  |  |  | 0.2 | V |
| Input High Voltage | VIH | DE，DI，RE |  | 2.0 |  |  | V |
| Input Low Voltage | VIL | DE，DI，RE |  |  |  | 0.8 | V |
| Input Current | IIN1 | DE，DI，RE |  |  |  | $\pm 2$ | $\mu \mathrm{A}$ |
| Input Current （A，B） | IIN2 | $\begin{aligned} & \mathrm{DE}=0 \mathrm{~V} ; \\ & \mathrm{VCC}=0 \mathrm{~V} \text { or } 5.25 \mathrm{~V}, \end{aligned}$ | $\mathrm{VIN}=12 \mathrm{~V}$ |  |  | 1.0 | mA |
|  |  |  | $\mathrm{VIN}=-7 \mathrm{~V}$ |  |  | －0．8 |  |
| Receiver Differential Threshold Voltage | VTH | $-7 \mathrm{~V} \leq \mathrm{V}_{\text {cm }} \leq 12 \mathrm{~V}$ |  | －0．2 |  | 0.2 | V |
| Receiver Input Hysteresis | $\Delta \mathrm{VTH}$ | $\mathrm{VCM}=0 \mathrm{~V}$ |  |  | 70 |  | mV |
| Receiver Output High Voltage | VOH | $I \mathrm{C}=-4 \mathrm{~mA}, \mathrm{VID}=200 \mathrm{mV}$ |  | 3.5 |  |  | V |
| Receiver Output Low Voltage | VOL | $\mathrm{IO}=4 \mathrm{~mA}, \mathrm{VID}=-200 \mathrm{mV}$ |  |  |  | 0.4 | V |
| Three－State（high impedance） Output Current at Receiver | IOZR | $0.4 \mathrm{~V} \leq \mathrm{VO} \leq 2.4 \mathrm{~V}$ |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| Receiver Input Resistance | RIN | $-7 \mathrm{~V} \leq \mathrm{VCM} \leq 12 \mathrm{~V}$ |  |  |  |  | k $\Omega$ |

## DC ELECTRICAL CHARACTERISTICS（continued）

（ $\mathrm{Vcc}=5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {min to }}$ Tmax，unless otherwise noted．）（Notes 1，2）

| PARAMETER | SYMBOL | CONDITIONS | MIN | $\begin{gathered} \hline \text { TY } \\ \text { P } \end{gathered}$ | MAX | $\begin{gathered} \hline \text { UNIT } \\ \mathrm{S} \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| No－Load Supply Current （Note 3） | ICC | $\mathrm{DE}=\mathrm{V}_{\mathrm{cc}}$ |  | 500 | 900 |  |
|  |  | RE $=0 \mathrm{~V}$ or VCC |  | 300 | 500 | $\mu \mathrm{A}$ |
|  |  | DE $=0 \mathrm{~V}$ |  |  |  |  |
| Driver Short－Circuit Current， |  |  |  |  |  |  |
|  | IOSD1 | $-7 \mathrm{~V} \leq \mathrm{VO} \leq 12 \mathrm{~V}$（Note 4） | 35 |  | 250 | mA |
| $\mathrm{VO}=$ High |  |  |  |  |  |  |
| Driver Short－Circuit Current， |  |  |  |  |  |  |
|  | IOSD2 | $-7 \mathrm{~V} \leq \mathrm{VO} \leq 12 \mathrm{~V}$（Note 4） | 35 |  | 250 | mA |
| VO＝Low |  |  |  |  |  |  |
| Receiver Short－Circuit Current | IOSR | $\mathrm{OV} \leq \mathrm{VO} \leq \mathrm{VCC}$ | 7 |  | 95 | mA |

## SWITCHING CHARACTERISTICS

（ $\mathrm{Vcc}=5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {min }}$ to $\mathrm{T}_{\mathrm{max}}$ ，unless otherwise noted．）（Notes 1，2）

| PARAMETER | $\underset{\mathrm{L}}{\mathrm{SYMBO}}$ | CONDITIONS | MIN | $\begin{aligned} & \text { TY } \\ & \mathbf{P} \end{aligned}$ | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Driver Input to Output | tPLH | RDIFF $=54 \Omega$ | 10 | 30 | 60 | ns |
|  | tPHL | CL1＝CL2 $=100 \mathrm{pF}$ | 10 | 30 | 60 |  |
| Driver Output Skew to Output | tSKEW | $\begin{aligned} & \text { RDIFF }=54 \Omega, \text { CL1 }=\text { CL2 }= \\ & 100 \mathrm{pF} \end{aligned}$ |  | 5 | 10 | ns |
| Driver Enable to Output High | tZH | CL＝100pF，S2 closed |  | 40 | 70 | ns |
| Driver Enable to Output Low | tZL | CL＝100pF，S1 closed |  | 40 | 70 | ns |
| Driver Disable Time from Low | tLZ | CL＝15pF，S1 closed |  | 40 | 70 | ns |
| Driver Disable Time from High | thZ | CL＝15pF，S2 closed |  | 40 | 70 | ns |
| ｜tPLH－tPHL｜Differential | tSKD | RDIFF $=54 \Omega$ |  | 13 |  | ns |
| Receiver Skew |  | CL1＝CL2＝100pF |  |  |  |  |
| Receiver Enable to Output Low | tZL | CRL $=15 \mathrm{pF}$ ，S1 closed |  | 20 | 50 | ns |
| Receiver Enable to Output High | tZH | CRL $=15 \mathrm{pF}$ ，S2 closed |  | 20 | 50 | ns |
| Receiver Disable Time from Low | tLZ | CRL $=15 \mathrm{pF}$ ，S1 closed |  | 20 | 50 | ns |
| Receiver Disable Time from High | thZ | CRL $=15 \mathrm{pF}$ ，S2 closed |  | 20 | 50 | ns |
| Maximum Data Rate | fMAX |  | 2.5 |  |  | Mbps |

Notes：
1．All currents into device pins are positive；all currents out of device pins are negative．All voltages are referenced to device ground unless otherwise specified．

2．All typical specifications are given for $\mathrm{VCC}=5 \mathrm{~V}$ and $\mathrm{TA}=+25^{\circ} \mathrm{C}$
3．Supply current specification is valid for loaded transmitters when $\mathrm{DE}=0 \mathrm{~V}$
4．Applies to peak current．See Typical Operating Characteristics．

## Operation timing diagrams



| Transmission |  |  |  |  | Receipt |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  | Outputs X |  | Inputs |  |  | Outputs |
| RE | DE | DI | Z | Y | RE | DE | A－B | RO |
| X | 1 | 1 | 0 | 1 | 0 | 0 | ＋0．2V | 1 |
| X | 1 | 0 | 1 | 0 | 0 | 0 | －0．2V | 0 |
| 0 | 0 | X | Z | Z | 0 | 0 | open | 1 |
| 1 | 0 | X | Z | Z | 1 | 0 | X | Z |

X－don＇t care
Z－high resistance

## （DIP8）



## $\oplus[0.25(0.010)(11) \mathrm{T}$

## NOTES：

1．Dimensions＂$A$＂，＂$B$＂do not include mold flash or protrusions．
Maximum mold flash or protrusions $0.25 \mathrm{~mm}(0.010)$ per side．

|  | Dimension，mm |  |
| :---: | :---: | :---: |
| Symbol | MIN | MAX |
| $\mathbf{A}$ | 8.51 | 10.16 |
| $\mathbf{B}$ | 6.1 | 7.11 |
| $\mathbf{C}$ |  | 5.33 |
| $\mathbf{D}$ | 0.36 | 0.56 |
| $\mathbf{F}$ | 1.14 | 1.78 |
| $\mathbf{G}$ | 2.54 |  |
| $\mathbf{H}$ | 7.62 |  |
| $\mathbf{J}$ | $0^{\circ}$ | $10^{\circ}$ |
| $\mathbf{K}$ | 2.92 | 3.81 |
| $\mathbf{L}$ | 7.62 | 8.26 |
| $\mathbf{M}$ | 0.2 | 0.36 |
| $\mathbf{N}$ | 0.38 |  |

## （SOP8）




## NOTES：

1．Dimensions $A$ and $B$ do not include mold flash or protrusion．
2．Maximum mold flash or protrusion $0.15 \mathrm{~mm}(0.006)$ per side for A ；for $\mathrm{B}-0.25 \mathrm{~mm}(0.010)$ per side．


|  | Dimension，mm |  |
| :---: | :---: | :---: |
| Symbol | MIN | MAX |
| $\mathbf{A}$ | 4.8 | 5 |
| $\mathbf{B}$ | 3.8 | 4 |
| $\mathbf{C}$ | 1.35 | 1.75 |
| $\mathbf{D}$ | 0.33 | 0.51 |
| $\mathbf{F}$ | 0.4 | 1.27 |
| $\mathbf{G}$ | 1.27 |  |
| $\mathbf{H}$ | 5.72 |  |
| $\mathbf{J}$ | $0^{\circ}$ | $8^{\circ}$ |
| $\mathbf{K}$ | 0.1 | 0.25 |
| $\mathbf{M}$ | 0.19 | 0.25 |
| $\mathbf{P}$ | 5.8 | 6.2 |
| $\mathbf{R}$ | 0.25 | 0.5 |

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